

## CKC18X562FDGAC7210

KC-LINK Auto COG, Ceramic, 5600 pF, 1%, 1000 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1812



Click here for the 3D model.

Dimensions	
Chip Size	1812
L	4.5mm +/-0.4mm
W	3.2mm +/-0.3mm
Т	1.25mm +/-0.15mm
В	0.7mm +/-0.35mm

Packaging Specifications	
Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	4000

General Information		
Series	KC-LINK Auto COG	
Style	SMD Chip	
Description	SMD, MLCC, FT-CAP, Ultra-Stable	
Features	FT-CAP, Ultra-Stable	
RoHS	Yes	
Termination	Flexible Termination	
Marking	No	
Qualifications	AEC-Q200	
AEC-Q200	Yes	
Component Weight	67 mg	
Shelf Life	78 Weeks	
MSL	1	

Specifications	
Capacitance	5600 pF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	1%
Voltage DC	1000 VDC
Dielectric Withstanding Voltage	1200 VDC
Temperature Range	-55/+150°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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